

ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.: SPCP022B
DEPT.	For CP04 Latch Type Series Power Connector	PAGE: 1 / 5

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and procedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

MIL - STD - 202 Methods for test of connectors for electronic equipment

MIL - STD - 1344 Test methods for electrical connectors

3. APPLICABLE SERIES NO.: CP04 With Latch Type Series

Housing: P/N: CP04**SL0*0

Header: P/N: CP04**P1*L0-LF

CP04**P1ML0-LF

Terminal: P/N: CP05T021PE0 or CP05T031PE0

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 P.C. Board Layout: See attached drawings



REVIEWED : ALEX APPROVED : DAVID VERIFIED : BILL .

ENGINEERING DEPT.	PRODUCT SPECIFICATION For CP04 Latch Type Series Power Connector	SPEC.NO.: SPCP022B
		PAGE: 2 / 5

7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage	Current rating:When applying AWG #22 wire	1.0A , AC, DC
		Voltage rating:2-circuit (12mm Pitch)	2000V AC,DC
		2-circuit (8mm Pitch) 2-circuit (4mm Pitch)	1500V AC,DC 1000V AC,DC
7.2	Contact resistance	Dry circuit of DC 20mV max. , 100mA max., Wire resistance shall be removed from the measured value.	Less than 10 mΩ
7.3	Dielectric strength	Applied 1minute between adjacent tetminal For 4 & 8mm Pitch: 1800 V AC For 12mm Pitch: 3000 V AC	No Breakdown
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 1000 MΩ

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Wire size	Specified wire size	Accepts AWG#22-#28
8.2	Terminal crimp strength	When crimped AWG#22 size wire	More than 5 kgf
		When crimped AWG#24 size wire	More than 3 kgf
		When crimped AWG#26 size wire	More than 2 kgf
		When crimped AWG#28 size wire	More than 1.3 kgf
8.3	Terminal insertion force	Insertion speed 25± 3 mm per minute into housing	Less than 0.5 kgf
8.4	Terminal retaining force in insulator	Retention speed 25± 3 mm per minute from Wire to Wire Housing	More than 1.0 kgf
8.5	Single contact insertion force	Measure force to insertion using mating square pin at speed 25± 3 mm per minute	500 gram max.
8.6	Single contact withdrawal force	Measure force to withdrawal using mating square pin at speed 25± 3 mm per minute	100 gram min.
8.7	Pin retention force in Board mount Header	Push Pin for insulator base at speed 25± 3 mm per minute	More than 1.0 kgf

ENGINEERING DEPT.	PRODUCT SPECIFICATION For CP04 Latch Type Series Power Connector	SPEC.NO.: SPCP022B
		PAGE: 3 / 5

	ITEM	TEST CONDITION	REQUIREMENT		
			Pin No	Mating (Max.)	Unmating (Min.)
8.8	Mating and Unmating force	Speed 25± 3 mm per minute			
			2	2.5 kgf	3.0 kgf
			3	3.5 kgf	3.0 kgf
			4	4.5 kgf	3.0 kgf
			5	5.5 kgf	3.0 kgf
8.9	Durability	Connector shall be subjected to 30 cycles of insertion and withdrawal	Contact resistance: Less than twice of initial		

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Vibration	1.5 mm 10-55-10 HZ/minute each 2 hours for X, Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.
9.3	Heat aging	85± 2°C, 96 hours	No damage
9.4	Humidity	40± 2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3
9.5	Temperature cycling	One cycle consists of : (1) -55 ⁺⁰ ₋₃ °C , 30 min. (2) Room temp. 10-15 min. (3) 85 ⁺³ ₋₀ °C , 30 min. (4) Room temp. 10-15 min. Total cycles : 5 cycles	Appearance: No damage Contact resistance: Less than twice of initial
9.6	Salt spray	Temperature: 35± 3°C Solution: 5± 1% Spray time: 48± 4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial



ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.: SPCP022B
DEPT.	For CP04 Latch Type Series Power Connector	PAGE: 4 / 5

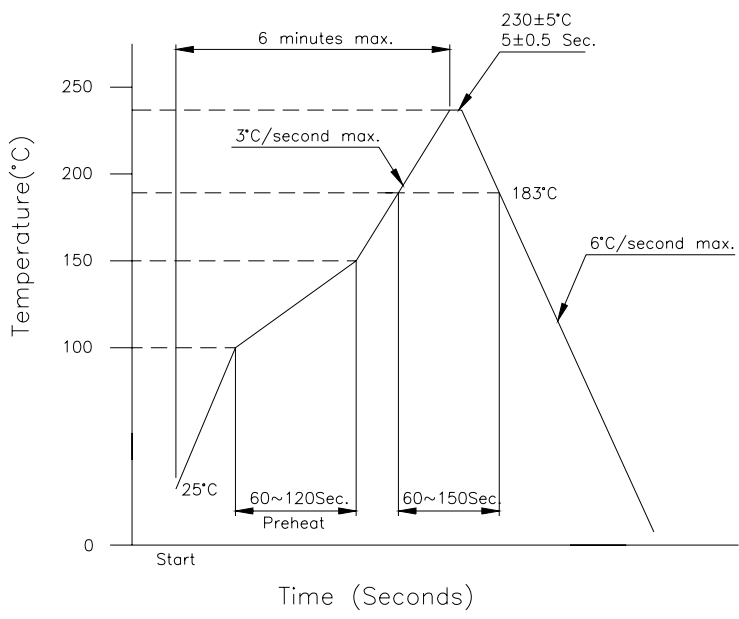
	ITEM	TEST CONDITION	REQUIREMENT
9.7	Solder ability	Tin-Lead Process: Soldering time: 5 ± 0.5 second Soldering pot: $230 \pm 5^{\circ}\text{C}$ Lead-Free Process: Soldering time: 3 ± 0.5 second Soldering pot: $245 \pm 5^{\circ}\text{C}$	Minimum: 90% of immersed area
9.8	Resistance to soldering heat	Tin-Lead Process for DIP Type: Soldering time: 5 ± 0.5 second Soldering pot: $260 \pm 5^{\circ}\text{C}$ Tin-Lead Process for SMT Type: Refer Reflow temperature profile(11.1) Lead-Free Process for SMT Type: Refer Reflow temperature profile(11.2)	No damage

10. AMBIENT TEMPERATURE RANGE: -25 to $+85^{\circ}\text{C}$

ENGINEERING DEPT.	PRODUCT SPECIFICATION	SPEC.NO.: SPCP022B
	For CP04 Latch Type Series Power Connector	PAGE: 5 / 5

11. Recommended IR Reflow Temperature Profile:

11.1 Using Typical Solder Paste



11.2 Using Lead-Free Solder Paste

